

MMIC

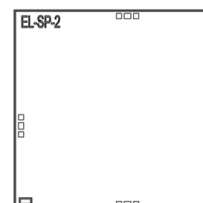
Power Splitter/Combiner Die

EP2RKU-D+

2 Way-0° 50Ω DC to 18 GHz

The Big Deal

- Ultra-Wide Bandwidth, DC to 18 GHz
- High Isolation, 21 dB typ. at 12 GHz
- High Power Handling, 0.6W as a splitter/combiner



Product Overview

Mini-Circuits' EP2RKU-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from DC to 18 GHz supporting many applications requiring high performance across a wide frequency range including all the LTE bands through WiMax an WiFi, as well as instrumentation and more. This model provides excellent power handling up to 0.6W (as a splitter/combiner) with low insertion loss, good isolation, and low phase and amplitude unbalance. Manufactured using GaAs IPD technology, the EP2RKU-D+ provides a high level of ESD protection and excellent repeatability.

Key Features

| Feature | Advantages |
|---|--|
| Wideband, DC to 18 GHz | One power splitter can be used in all the LTE bands through WiMAX and WiFi, saving component count. Also ideal for wideband applications such as military and instrumentation. |
| Excellent power handling <ul style="list-style-type: none">• 0.6W as a splitter• 0.6W internal dissipation as a combiner | In power combiner applications, half the power is dissipated internally. EP2RKU-D+ is designed to handle 0.6W internal dissipation as a combiner allowing reliable operation without excessive temperature rise. |
| Unpackaged Die | Enables user to integrate it directly into hybrids. |



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Power Splitter/Combiner Die

EP2RKU-D+

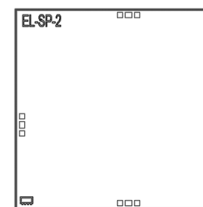
2 Way-0° 50Ω DC to 18 GHz

Product Features

- Wide bandwidth, DC to 18 GHz
- Excellent amplitude unbalance, 0.1 dB typ. up to 18 GHz
- Good phase unbalance, 0.5 deg. typ. at 12 GHz
- High ESD level
- Patent pending

Typical Applications

- WiMAX
- ISM
- Instrumentation
- Radar
- WLAN
- Satellite communications
- LTE



+RoHS Compliant

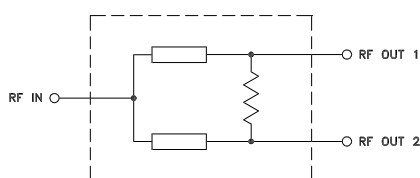
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page

General Description

Mini-Circuits' EP2RKU-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from DC to 18 GHz supporting many applications requiring high performance across a wide frequency range including all the LTE bands through WiMax an WiFi, as well as instrumentation and more. This model provides excellent power handling up to 0.6W (as a splitter/combiner) with low insertion loss, good isolation, and low phase and amplitude unbalance. Manufactured using GaAs IPD technology, the EP2RKU-D+ provides a high level of ESD protection and excellent repeatability.

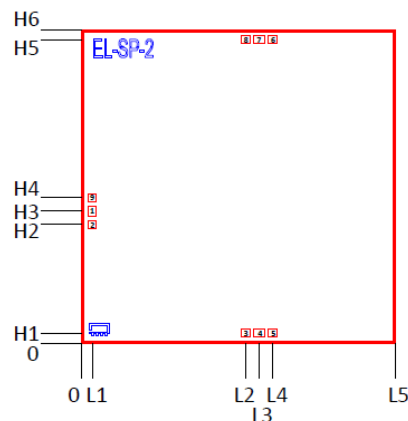
Simplified Schematic and Pad Description



| Pad# | Function |
|-------------|-------------------|
| 1 | Sum Port (RF IN) |
| 4 | Port 1 (RF OUT 2) |
| 7 | Port 2 (RF OUT 1) |
| 2,3,5,6,8,9 | Ground |

Note: 1. Bond Pad material - Gold
2. Bottom of Die is ground - Gold plated

Bonding Pad Position



| L1 | L2 | L3 | L4 | L5 | H1 | H2 | H3 | H4 | H5 | H6 | Thickness | Die Size | Pad Size 1 | Pad Size 2,3,5,6,8,9 | Pad Size 4&7 |
|-----|------|------|------|------|-----|------|------|------|------|------|-----------|-----------|------------|----------------------|--------------|
| 119 | 1832 | 1982 | 2132 | 3500 | 113 | 1327 | 1477 | 1627 | 3393 | 3500 | 100 | 3500x3500 | 92x117 | 92x92 | 117x92 |



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REV. OR
ECO-000438
EP2RKU-D+
MCL NY
191022
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Electrical Specifications at 25°C¹

| Parameter | | Frequency (GHz) | Min. | Typ. | Max. | Unit |
|------------------------------|---------------|-----------------|------|------|------|--------|
| Frequency Range | | | DC | | 18 | GHz |
| Insertion Loss, above 3.0 dB | | DC - 4 | — | 2.9 | — | dB |
| | | 4 - 18 | — | 2.9 | — | |
| Isolation | | DC - 4 | — | 12.6 | — | dB |
| | | 4 - 18 | — | 23 | — | |
| Phase Unbalance | | DC - 4 | — | 0.1 | — | Degree |
| | | 4 - 18 | — | 0.6 | — | |
| Amplitude Unbalance | | DC - 4 | — | 0.1 | — | dB |
| | | 4 - 18 | — | 0.1 | — | |
| VSWR (Port S) | | DC - 4 | — | 1.5 | — | :1 |
| | | 4 - 18 | — | 1.3 | — | |
| VSWR (Port 1-2) | | DC - 4 | — | 1.3 | — | :1 |
| | | 4 - 18 | — | 1.3 | — | |
| Power Handling | As a splitter | DC - 18 | — | — | 0.6 | W |
| | As a combiner | DC - 18 | — | — | 0.6 | |

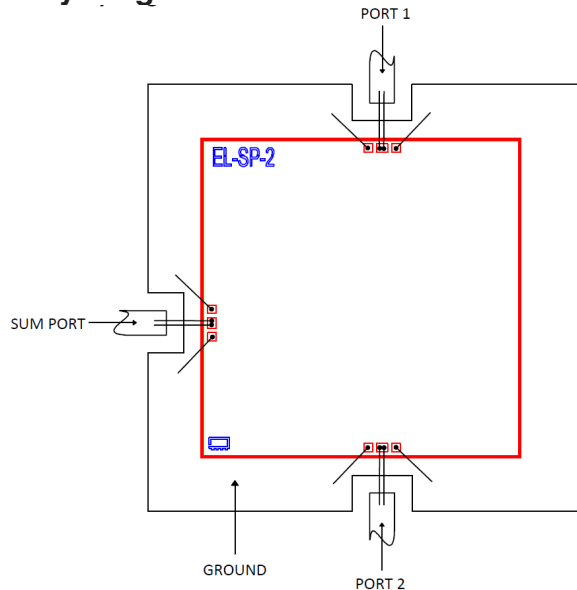
1. Measured on die using MPI Titan series 150 µm pitch as probe

Maximum Ratings

| Parameter | Ratings |
|-----------------------|----------------|
| Operating Temperature | -55°C to 105°C |

Permanent damage may occur if any of these limits are exceeded.

Assembly Diagram



Assembly and Handling Procedure

1. **Storage**
Dice should be stored in a dry nitrogen purged desiccators or equivalent.
2. **ESD**
MMIC dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.
3. **Die Attach**
The Die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030HK-PT/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total Die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic Die pick up tools only.
4. **Wire Bonding**
Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the Die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.

| Additional Detailed Technical Information | | | | | | | |
|---|---|-------------------|-----------|------------------------|------------|---|------------|
| <i>additional information is available on our dash board.</i> | | | | | | | |
| Performance Data | Data Table | | | | | | |
| | Swept Graphs | | | | | | |
| | S-Parameter (S3P Files) Data Set with and without port extension(.zip file) | | | | | | |
| Case Style | Die | | | | | | |
| Die Ordering and packaging information | <table> <tr> <td>Quantity, Package</td><td>Model No.</td></tr> <tr> <td>Small, Gel - Pak: 5,10</td><td>EP2RKU-DG+</td></tr> <tr> <td>Medium[†], Partial wafer: 225 Max.</td><td>EP2RKU-DP+</td></tr> </table> <p>[†]Available upon request contact sales representative</p> <p>Refer to AN-60-067</p> | Quantity, Package | Model No. | Small, Gel - Pak: 5,10 | EP2RKU-DG+ | Medium [†] , Partial wafer: 225 Max. | EP2RKU-DP+ |
| Quantity, Package | Model No. | | | | | | |
| Small, Gel - Pak: 5,10 | EP2RKU-DG+ | | | | | | |
| Medium [†] , Partial wafer: 225 Max. | EP2RKU-DP+ | | | | | | |
| Environmental Ratings | ENV-80 | | | | | | |

ESD Rating**

Human Body Model (HBM): Class 2 (Pass 2000V) in accordance with ANSI/ESD STM 5.1 - 2001

** Tested in industry standard, 5x5mm, 32-lead MCLP package.

Additional Notes

- Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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2 Way-0° Power Splitter/Combiner Die

EP2RKU-D+

Typical Performance Data

TEST CONDITIONS: Input Power = -10dBm @Temperature = +25°C

| FREQ. (MHz) | TOTAL LOSS ⁽¹⁾ | | AMP. UNBAL. | PHASE UNBAL. | ISOLATION | VSWR | | |
|----------------|---------------------------|-------------|----------------|-----------------|-------------|-----------|-----------|-----------|
| | (dB) S-1 | (dB) S-2 | (dB) | (deg.) | (dB) 2-1 | (:1) S | (:1) 1 | (:1) 2 |
| 100 | 5.85 | 5.88 | 0.04 | 0.01 | 9.68 | 1.54 | 1.04 | 1.04 |
| 200 | 5.84 | 5.88 | 0.04 | 0.00 | 9.72 | 1.53 | 1.06 | 1.06 |
| 400 | 5.85 | 5.89 | 0.04 | 0.03 | 9.85 | 1.53 | 1.10 | 1.10 |
| 600 | 5.86 | 5.90 | 0.04 | 0.02 | 10.04 | 1.53 | 1.14 | 1.14 |
| 800 | 5.87 | 5.91 | 0.04 | 0.02 | 10.28 | 1.52 | 1.18 | 1.18 |
| 1000 | 5.87 | 5.91 | 0.04 | 0.04 | 10.55 | 1.52 | 1.22 | 1.22 |
| 1200 | 5.88 | 5.92 | 0.03 | 0.03 | 10.87 | 1.52 | 1.25 | 1.25 |
| 1400 | 5.88 | 5.92 | 0.04 | 0.05 | 11.22 | 1.51 | 1.29 | 1.28 |
| 1600 | 5.89 | 5.93 | 0.03 | 0.05 | 11.58 | 1.51 | 1.31 | 1.31 |
| 1800 | 5.90 | 5.94 | 0.04 | 0.06 | 11.96 | 1.51 | 1.34 | 1.34 |
| 2000 | 5.90 | 5.94 | 0.04 | 0.07 | 12.35 | 1.50 | 1.36 | 1.36 |
| 2200 | 5.91 | 5.94 | 0.03 | 0.07 | 12.75 | 1.50 | 1.38 | 1.38 |
| 2400 | 5.91 | 5.95 | 0.03 | 0.07 | 13.16 | 1.49 | 1.40 | 1.40 |
| 2600 | 5.91 | 5.95 | 0.04 | 0.08 | 13.57 | 1.49 | 1.42 | 1.41 |
| 2800 | 5.91 | 5.95 | 0.04 | 0.09 | 14.00 | 1.48 | 1.43 | 1.43 |
| 3000 | 5.92 | 5.96 | 0.03 | 0.10 | 14.42 | 1.48 | 1.44 | 1.44 |
| 3200 | 5.93 | 5.96 | 0.04 | 0.09 | 14.86 | 1.47 | 1.45 | 1.45 |
| 3400 | 5.93 | 5.96 | 0.04 | 0.12 | 15.30 | 1.47 | 1.46 | 1.45 |
| 3600 | 5.93 | 5.97 | 0.04 | 0.13 | 15.75 | 1.46 | 1.46 | 1.46 |
| 3800 | 5.93 | 5.96 | 0.03 | 0.13 | 16.20 | 1.46 | 1.47 | 1.46 |
| 4000 | 5.94 | 5.97 | 0.03 | 0.11 | 16.67 | 1.45 | 1.47 | 1.47 |
| 4200 | 5.94 | 5.97 | 0.03 | 0.07 | 17.16 | 1.44 | 1.47 | 1.47 |
| 4400 | 5.94 | 5.97 | 0.03 | 0.05 | 17.65 | 1.43 | 1.47 | 1.47 |
| 4600 | 5.94 | 5.98 | 0.04 | 0.08 | 18.16 | 1.42 | 1.48 | 1.47 |
| 4800 | 5.94 | 5.98 | 0.04 | 0.10 | 18.69 | 1.42 | 1.48 | 1.47 |
| 5000 | 5.94 | 5.98 | 0.04 | 0.10 | 19.24 | 1.41 | 1.48 | 1.47 |
| 5500 | 5.94 | 5.99 | 0.05 | 0.09 | 20.71 | 1.38 | 1.48 | 1.47 |
| 6000 | 5.95 | 5.99 | 0.05 | 0.14 | 22.45 | 1.35 | 1.47 | 1.46 |
| 6500 | 5.93 | 5.96 | 0.03 | 0.19 | 24.49 | 1.33 | 1.47 | 1.46 |
| 7000 | 5.92 | 5.95 | 0.04 | 0.16 | 26.95 | 1.31 | 1.46 | 1.46 |
| 7500 | 5.91 | 5.95 | 0.04 | 0.13 | 29.93 | 1.29 | 1.45 | 1.45 |
| 8000 | 5.90 | 5.95 | 0.05 | 0.12 | 33.00 | 1.28 | 1.44 | 1.44 |
| 8500 | 5.90 | 5.95 | 0.05 | 0.12 | 33.76 | 1.28 | 1.43 | 1.43 |
| 9000 | 5.90 | 5.95 | 0.05 | 0.15 | 31.28 | 1.29 | 1.42 | 1.41 |
| 9500 | 5.90 | 5.95 | 0.05 | 0.19 | 28.45 | 1.31 | 1.40 | 1.40 |
| 10000 | 5.89 | 5.95 | 0.05 | 0.19 | 26.12 | 1.34 | 1.37 | 1.38 |
| 10500 | 5.90 | 5.96 | 0.05 | 0.13 | 24.28 | 1.37 | 1.35 | 1.35 |
| 11000 | 5.91 | 5.97 | 0.06 | 0.11 | 22.82 | 1.39 | 1.32 | 1.32 |
| 11500 | 5.92 | 5.98 | 0.06 | 0.11 | 21.62 | 1.41 | 1.28 | 1.28 |
| 12000 | 5.93 | 5.99 | 0.07 | 0.14 | 20.72 | 1.42 | 1.24 | 1.24 |
| 12500 | 5.92 | 5.99 | 0.07 | 0.20 | 20.04 | 1.41 | 1.19 | 1.19 |
| 13000 | 5.89 | 5.97 | 0.08 | 0.26 | 19.48 | 1.39 | 1.14 | 1.15 |
| 13500 | 5.85 | 5.93 | 0.08 | 0.26 | 19.09 | 1.36 | 1.10 | 1.10 |
| 14000 | 5.80 | 5.87 | 0.07 | 0.27 | 18.88 | 1.31 | 1.08 | 1.08 |
| 14500 | 5.74 | 5.80 | 0.06 | 0.32 | 18.84 | 1.25 | 1.10 | 1.10 |
| 15000 | 5.67 | 5.74 | 0.06 | 0.32 | 19.03 | 1.19 | 1.14 | 1.14 |
| 15500 | 5.62 | 5.68 | 0.06 | 0.34 | 19.51 | 1.15 | 1.19 | 1.20 |
| 16000 | 5.58 | 5.64 | 0.06 | 0.33 | 20.23 | 1.15 | 1.25 | 1.25 |
| 16500 | 5.58 | 5.62 | 0.05 | 0.27 | 21.17 | 1.20 | 1.30 | 1.30 |
| 17000 | 5.60 | 5.64 | 0.04 | 0.17 | 22.23 | 1.29 | 1.33 | 1.34 |
| 17500 | 5.64 | 5.69 | 0.05 | 0.08 | 23.28 | 1.39 | 1.37 | 1.37 |
| 18000 | 5.70 | 5.77 | 0.07 | 0.05 | 23.98 | 1.48 | 1.39 | 1.39 |

⁽¹⁾Total Loss = Insertion Loss + 3dB Splitter Loss



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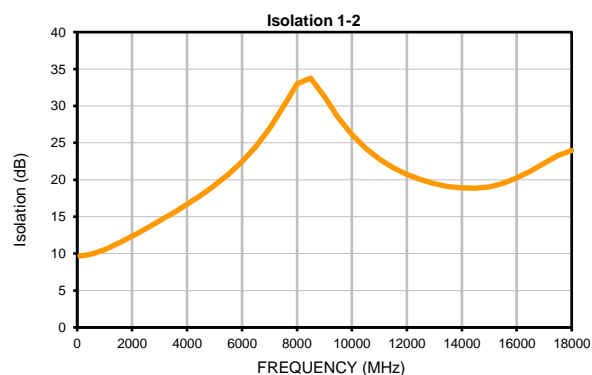
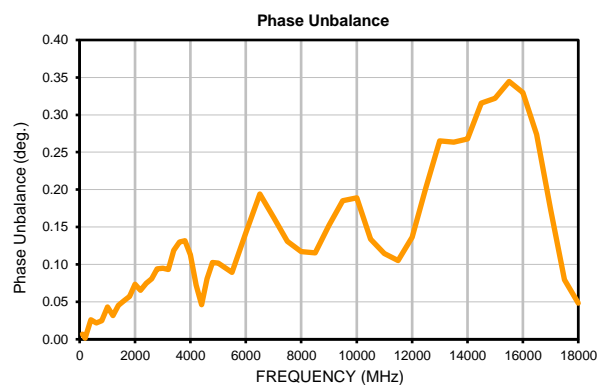
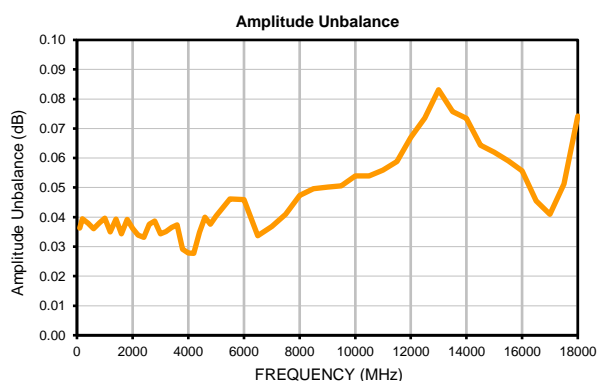
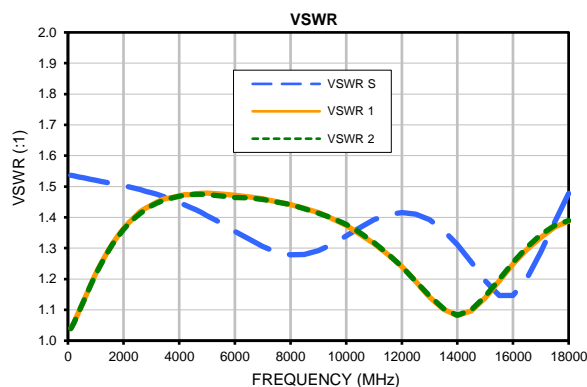
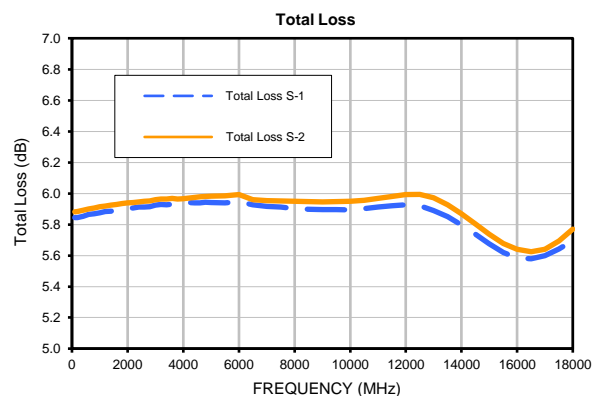
IF/RF MICROWAVE COMPONENTS

REV. OR
EP2RKU-D+
12/13/2019
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2 Way-0° Power Splitter/Combiner Die

EP2RKU-D+

Typical Performance Curves





All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|--------------------------------|--|--------------------------------------|
| Operating Temperature | -40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment | Refer to Individual Model Data Sheet |
| Storage Environment (Die) | -65° to 150°C | Individual Model Data Sheet |
| Storage Environment(Packaging) | -40° to 70°C and 40 to 60% humidity (In Factory Shipped Package) | |